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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
JIA-PING WANG	09/18/2008
QUN-FENG CHENG	09/18/2008
KAI-LI JIANG	09/18/2008
SHOU-SHAN FAN	09/18/2008

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### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12246356

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**PATENT** 500668312 **REEL: 021639 FRAME: 0364** 

NAME OF SUBMITTER:	D. Austin Bonderer
Total Attachments: 2 source=US18061080917ASM#page1.tif	
source=US18061080917ASM#page2.tif	

PATENT REEL: 021639 FRAME: 0365

## **ASSIGNMENT**

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

1.	Jia-Ping Wang	, residing at	Bei-Jing, China	
2.	Qun-Feng Cheng	, residing at	Bei-Jing, China	
3.	Kai-Li Jiang	, residing at	Bei-Jing, China	
4.	Shou-Shan Fan	, residing at	Bei-Jing, China	
		, residing at		
		, residing at		

hereby sell(s), assign(s) and transfer(s) unto: Tsinghua University, a university having an office and place of business at No.1,Qinghua Yuan, Haidian District, Beijing City, China, P.R.C. and Hon Hai Precision Ind. Co., LTD. having a principal place of business at 66 Chung Shan Road, Tu-Cheng City, Taipei Hsien, Taiwan, R.O.C. hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as **METHOD FOR MAKING CARBON NANOTUBE COMPOSITE** for which the undersigned

	] previously executed Ser. No.	and filing date of	
[x]:	is executing concurrently herewith		

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

1.	diaping Wong	Sep.18,2008	
• •	Jia-Ping Wang inventor	Date	Witness
2	Qun-Feng Cheng inventor	Sep.18,2008  Date	Witness
3	Kai-Li Jiang inventor	Sep.18,2008  Date	Witness
4	Shou-Shan Fan inventor	Sep.18,2008  Date	Witness
5	inventor	Date	Witness
6.	inventor	Date	Witness
7.	inventor	Date	Witness
8.	inventor	Date	Witness

PATENT REEL: 021639 FRAME: 0367